

SS32 THRU SS3A

SCHOTTKY BARRIER RECTIFIERS

Reverse Voltage – 20 to 100 Volts

Forward Current – 3.0 Amperes

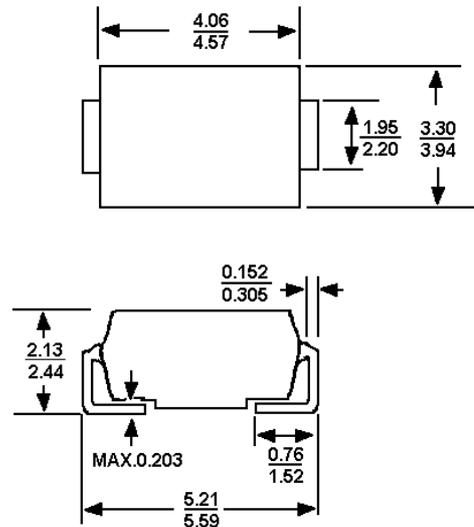
Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Metal silicon junction, majority carrier conduction
- For surface mount applications
- Low power loss, high efficiency
- High current capability, Low forward voltage drop.
- Low profile package
- Built-in strain relief, ideal for automated placement
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- High temperature soldering guaranteed: 250/10sec at terminals

Mechanical Data

- **Case:** JEDEC DO-214AA, molded plastic body
- **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026
- **Polarity:** Color band denotes cathode end

SMB/DO214AA



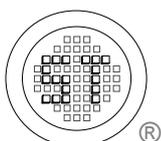
Dimensions in mm

Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, resistive or inductive load .For capacitive load , derate by 20%.

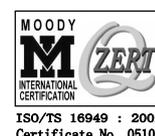
	Symbols	SS32	SS33	SS34	SS35	SS36	SS38	SS3A	Units
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	80	100	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	57	71	V
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	80	100	V
Maximum average forward rectified current at 0.375"(9.5mm) lead length	$I_{F(AV)}$	3.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	80							A
Maximum Instantaneous forward voltage at 3.0A (Note 1)	V_F	0.50		0.75		0.85		V	
Maximum instantaneous reverse Current at rated DC blocking at voltage (Note 1)	I_R	1.5							mA
		20		10					
Typical junction capacitance	C_{tot}	250			160				pF
Typical thermal resistance (Note 2)	$R_{\theta JA}$	55.0							°C/W
	$R_{\theta JA}$	17.0							
Operating junction temperature range	T_J	-65 to +125			-65 to +150				°C
Storage temperature range	T_S	-65 to +150							°C

- Notes: 1. Pulse test: 300µs pulse width, 1% duty cycle
2. P.C.B. mounted 0.55X0.55"(14X14mm) copper pad areas



SEMTECH ELECTRONICS LTD.

(Subsidiary of Semtech International Holdings Limited, a company listed on the Hong Kong Stock Exchange, Stock Code: 724)



ISO/TS 16949 : 2002
Certificate No. 05103



ISO 14001
Certificate No. 7116



ISO 9001 : 2000
Certificate No. 0361004002

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FIG. 1-FORWARD CURRENT DERATING CURVE

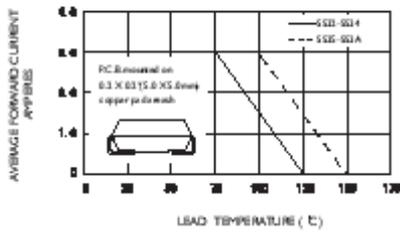


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

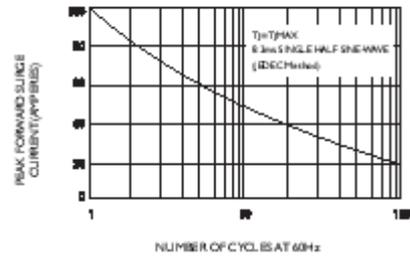


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

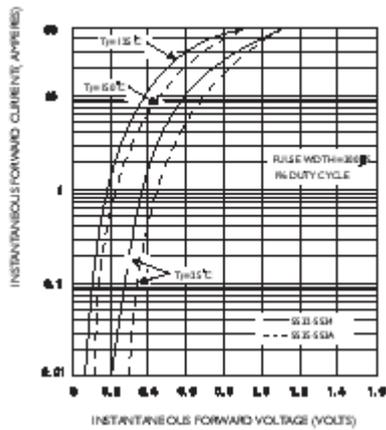


FIG.4-TYPICAL REVERSE CHARACTERISTICS

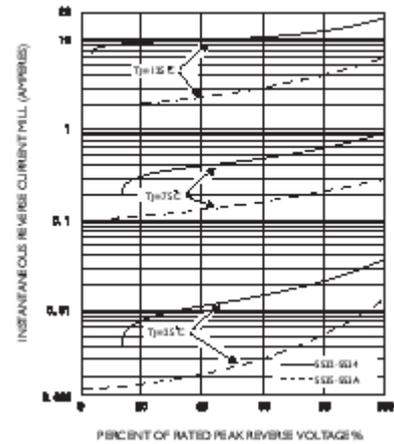


FIG.5-TYPICAL JUNCTION CAPACITANCE

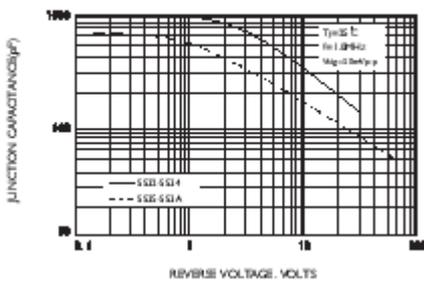
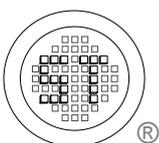
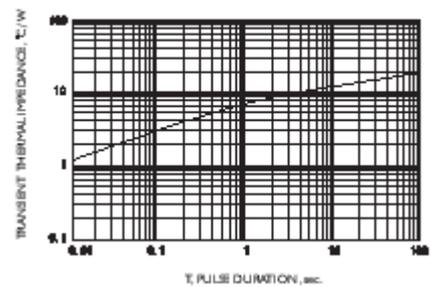


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE



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